

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: Zhao, Bin

Serial No.: 09/686,323

Filed: October 9, 2000

For: Method of Fabricating an Interconnect
Structure Employing Air Gaps Between
Metal Lines and Between Metal Layers

Art Unit: 2814

Examiner: Peralta, Ginette

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AMWAMENDMENT AND RESPONSE TO FINAL OFFICE ACTION

Mail Stop AF
Honorable Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir/Madam:

This is in response to the *Final Office Action* dated August 25, 2004 in the above-referenced patent application. Please enter and consider the following amendments and remarks.